

L Number	Hits	Search Text	DB	Time stamp
1	0	"09806099"	USPAT; EPO; JPO; DERWENT	2003/12/09 12:39
2	0	"09806099"	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/12/09 12:39
3	6	("9806099").PN.	USPAT; EPO; JPO; DERWENT	2003/12/09 12:39
4	1179	(15/77,102,88.1,88.221.1).CCLS.	USPAT; EPO; JPO; DERWENT	2003/12/09 12:58
5	204	((15/77,102,88.1,88.221.1).CCLS.) and (wafer or semiconductor)	USPAT; EPO; JPO; DERWENT	2003/12/09 12:58
6	2777	(134/902,144,153,95.3).CCLS.	USPAT; EPO; JPO; DERWENT	2003/12/09 12:58
7	1582	((134/902,144,153,95.3).CCLS.) and (wafer or semiconductor)	USPAT; EPO; JPO; DERWENT	2003/12/09 12:59
8	2771	H01L021/68.ipc. and (tokyo adj electron)	USPAT; EPO; JPO; DERWENT	2003/12/09 12:59
9	1642	(H01L021/68.ipc. and (tokyo adj electron)) and wafer	USPAT; EPO; JPO; DERWENT	2003/12/09 12:59
10	8	((H01L021/68.ipc. and (tokyo adj electron)) and wafer) and brush	USPAT; EPO; JPO; DERWENT	2003/12/09 12:59